

## **MOSFET**

### OptiMOS<sup>™</sup> 6 Power-Transistor, 200 V

#### **Features**

- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM) Very low reverse recovery charge (Q<sub>rr</sub>)
- · High avalanche energy rating

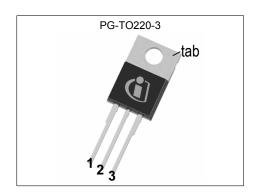
- 175°C operating temperature
  Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020
- 100% avalanche tested

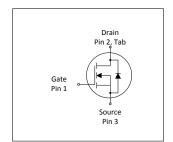


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

Parameter	Value	Unit
$V_{ t DS}$	200	V
$R_{\mathrm{DS(on),max}}$	6.9	mΩ
$I_{D}$	136	A
Qoss	232	nC
Q <sub>G</sub>	73	nC
Q <sub>rr</sub> (1000A/µs)	391	nC











Type / Ordering Code	Package	Marking	Related Links
IPP069N20NM6	PG-TO220-3	069N20N6	-

# OptiMOS<sup>™</sup> 6 Power-Transistor, 200 V



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# OptiMOS<sup>™</sup> 6 Power-Transistor, 200 V IPP069N20NM6



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Developeday	Oursels al	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	136 96 101 15.3	A	V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C V <sub>GS</sub> =10 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =15 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =10 V,T <sub>A</sub> =25°C,R <sub>thJA</sub> =40°C/W <sup>2</sup> )	
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	544	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	516	mJ	$I_{\rm D}$ =77 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	300 3.8	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =40 °C/W <sup>2)</sup>	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-	

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.31	0.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)		-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	_	-	62	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 6 Power-Transistor, 200 V IPP069N20NM6



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Danamatan	Valu			Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	200	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =258 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =160 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =160 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	$I_{\mathrm{GSS}}$	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	5.9 5.2	6.9 6.3	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =100 A V <sub>GS</sub> =15 V, I <sub>D</sub> =100 A	
Gate resistance	R <sub>G</sub>	-	3.8	-	Ω	-	
Transconductance <sup>1)</sup>	<b>g</b> fs	33	65	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 100 A$	

Table 5 **Dynamic characteristics** 

Paramatan	Oah al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	5700	7400	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =100 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	910	1200	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =100 V, f=1 MHz	
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	30	52	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =100 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	17	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	56	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	37	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	29	-	ns	$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$	

Gate charge characteristics<sup>2)</sup> Table 6

Davamatar	Councile of		Values			Nata / Tast Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	38	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	Q <sub>g(th)</sub>	-	21	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	14	21	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	31	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	<b>Q</b> g	-	73	110	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	6.6	-	V	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	63	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	232	302	nC	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V	

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

# OptiMOS<sup>™</sup> 6 Power-Transistor, 200 V IPP069N20NM6

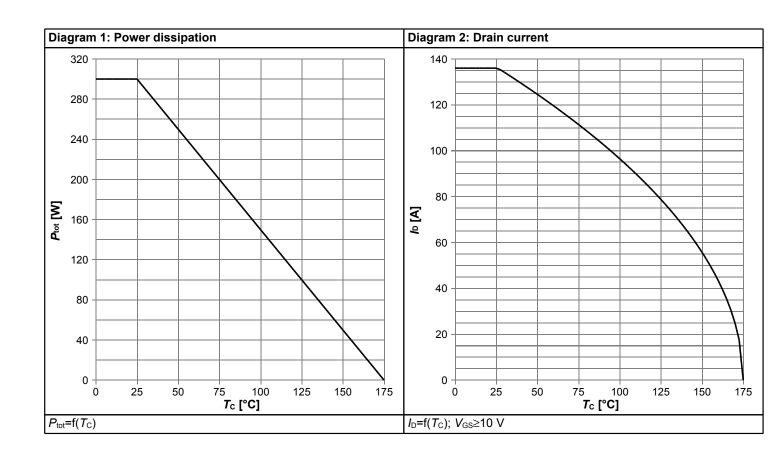


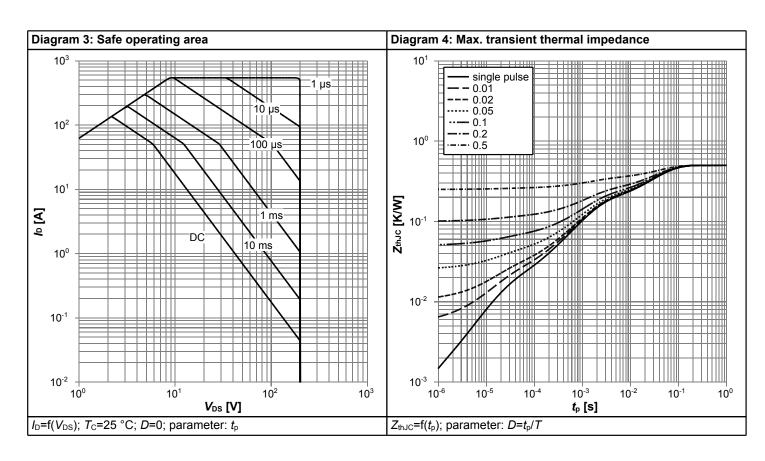
#### Table 7 Reverse diode

Dougnatou	Cumbal		Values			Nata / Tank Oam difficu	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	136	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	544	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.92	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =100 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	<i>t</i> <sub>rr</sub>	-	53	-	ns	V <sub>R</sub> =100 V, I <sub>F</sub> =50 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	70	140	nC	$V_{R}$ =100 V, $I_{F}$ =50 A, $di_{F}/dt$ =100 A/ $\mu$ s	
Reverse recovery time <sup>1)</sup>	<i>t</i> <sub>rr</sub>	-	38	-	ns	V <sub>R</sub> =100 V, I <sub>F</sub> =50 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =1000 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	391	782	nC	V <sub>R</sub> =100 V, I <sub>F</sub> =50 A, di <sub>F</sub> /dt=1000 A/μs	

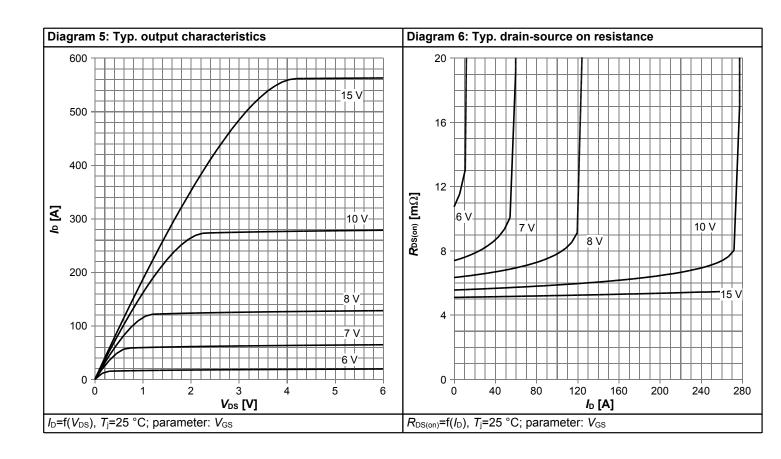


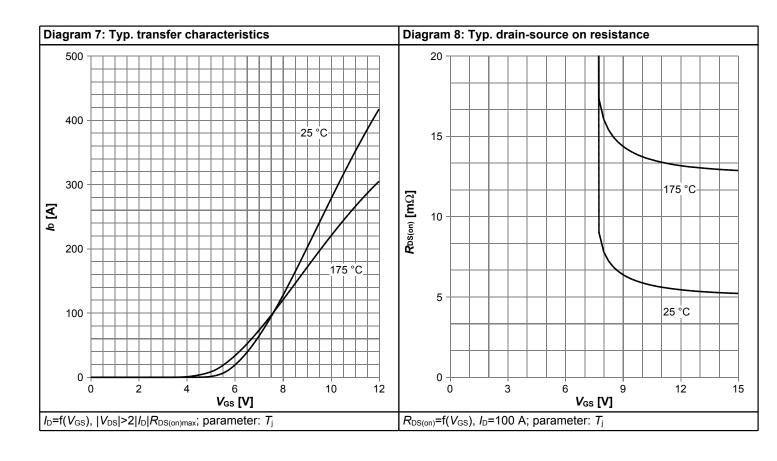
## 4 Electrical characteristics diagrams



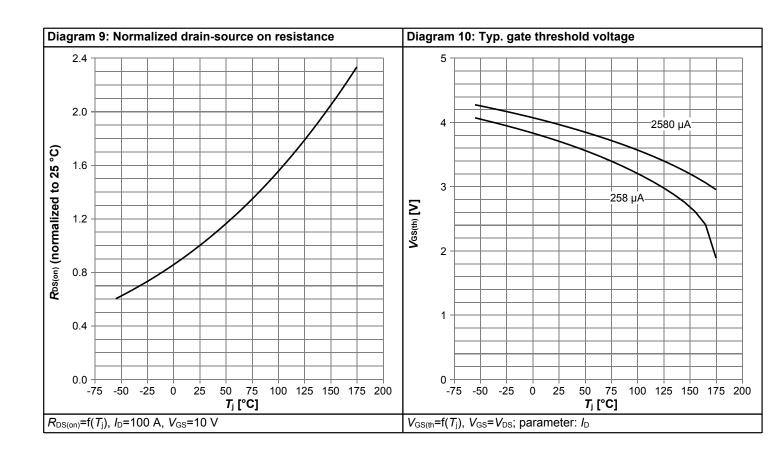


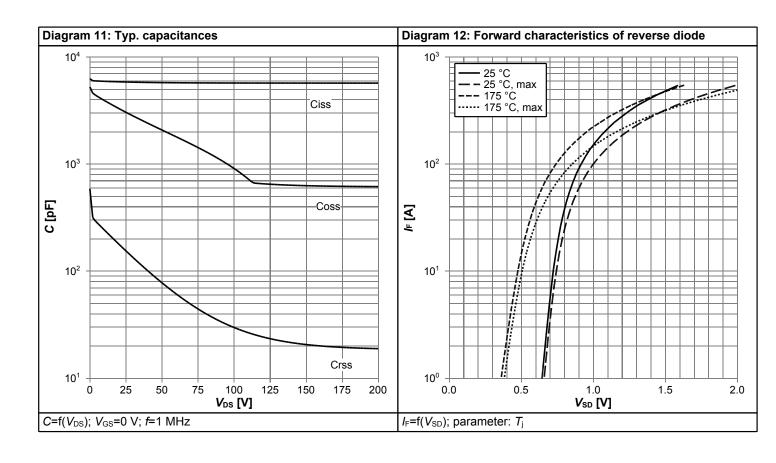




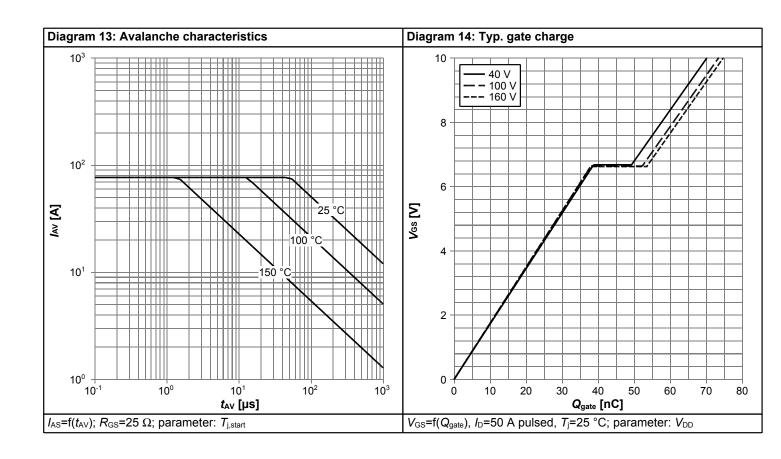


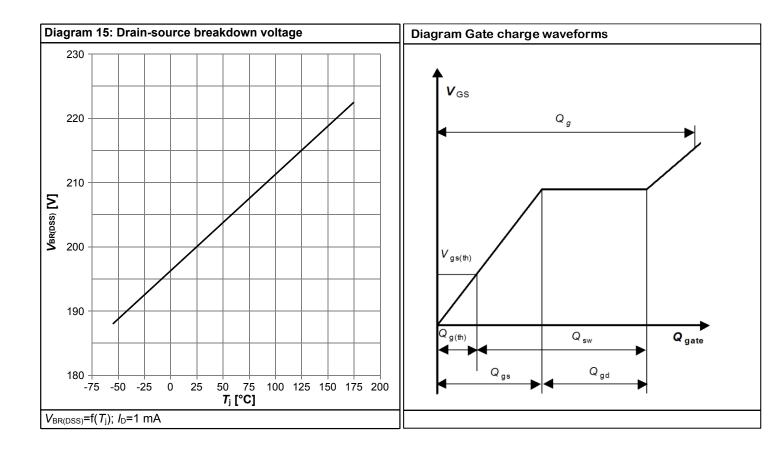






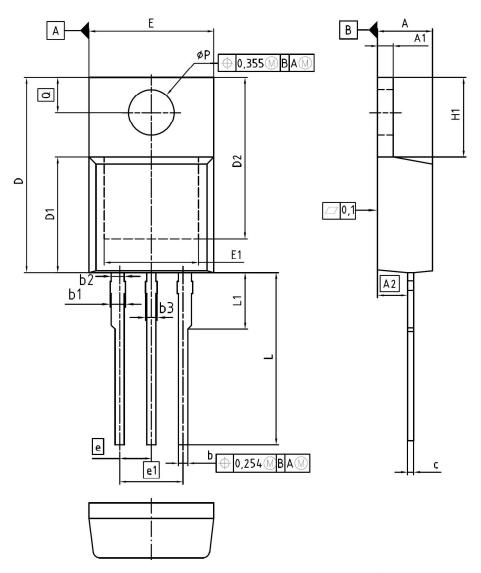








# 5 Package Outlines



DIM	MILLIM	ETERS	INCH	HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	1.17	1.40	0.046	0.055	
A2	2.15	2.72	0.085	0.107	
b	0.65	0.86	0.026	0.034	
b1	0.95	1.40	0.037	0.055	
b2	0.95	1.15	0.037	0.045	
b3	0.65	1.15	0.026	0.045	
С	0.33	0.60	0.013	0.024	
D	14.81	15.95	0.583	0.628	
D1	8.51	9.45	0.335	0.372	
D2	12.19	13.10	0.480	0.516	
Ε	9.70	10.36	0.382	0.408	
E1	6.50	8.60	0.256	0.339	
е	2.	54	0.100		
e1	5.0	08	0.2	200	
N		3	;	3	
H1	5.90	6.90	0.232	0.272	
L	13.00	14.00	0.512	0.551	
L1	-	4.80	-	0.189	
øΡ	3.60	3.89	0.142	0.153	
Q	2.60	3.00	0.102	0.118	

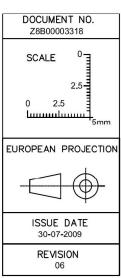


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

# OptiMOS<sup>TM</sup> 6 Power-Transistor, 200 V IPP069N20NM6



#### **Revision History**

IPP069N20NM6

Revision: 2023-12-07, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2023-12-07	Release of final version				

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